

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



March 2015

FDD6637

35V P-Channel PowerTrench^ò MOSFET

General Description

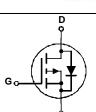
This P-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench technology to deliver low Rdson and optimized Bvdss capability to offer superior performance benefit in the applications.

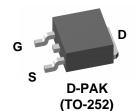
Applications

- Inverter
- Power Supplies

Features

- -55 A, -35 V $R_{DS(ON)}$ = 11.6 m Ω @ V_{GS} = -10 V $R_{DS(ON)}$ = 18 m Ω @ V_{GS} = -4.5 V
- High performance trench technology for extremely low $R_{\text{DS(ON)}}$
- RoHS Compliant





Absolute Maximum Ratings T_A=2

T_A=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source Voltage			-35	V	
V _{DS(Avalanche)}	Drain-Source Avalanche V	oltage (maximur	n) (Note 4)	-40	V	
V _{GSS}	Gate-Source Voltage			±25	V	
I _D	Continuous Drain Current	@T _C =25°C	(Note 3)	-55	A	
		@T _A =25°C	(Note 1a)	-13		
		Pulsed	(Note 1a)	-100		
P_D	Power Dissipation	@T _C =25°C	(Note 3)	57	W	
		@ T _A =25°C	(Note 1a)	3.1		
		@ T _A =25°C	(Note 1b)	1.3		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		ire Range	-55 to +150	°C	

Thermal Characteristics

R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	2.2	°C/W
R _{eJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	
R _{e,IA}	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	

Package Marking and Ordering Information

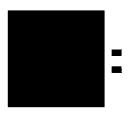
Device Marking	Device	Package	Reel Size	Tape width	Quantity	
FDD6637	FDD6637	D-PAK (TO-252)	13"	16mm	2500 units	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings			ı		ı
E _{AS}	Drain-Source Avalanche Energy (Single Pulse)	$V_{DD} = -35 \text{ V}, I_{D} = -11 \text{ A}, L = 1 \text{mH}$		61		mJ
I _{AS}	Drain-Source Avalanche Current			-14		Α
Off Chara	acteristics(Note 2)					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = -250 \mu\text{A}$	-35			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -28$ V, $V_{GS} = 0$ V			-1	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 25 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1	-1.6	-3	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, I_D = -14 \text{ A}$ $V_{GS} = -4.5 \text{ V}, I_D = -11 \text{ A}$ $V_{GS} = -10 \text{ V}, I_D = -14 \text{ A}, T_J = 125^{\circ}\text{C}$		9.7 14.4 14.7	11.6 18 19	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = -5 \text{ V}, \qquad I_{D} = -14 \text{ A}$		35		S
Dynamic	Characteristics	•		•		•
C _{iss}	Input Capacitance			2370		pF
Coss	Output Capacitance	$V_{DS} = -20 \text{ V}, \qquad V_{GS} = 0 \text{ V},$		470		pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		250		pF
R_G	Gate Resistance	f = 1.0 MHz		3.6		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time			18	32	ns
t _r	Turn–On Rise Time	$V_{DD} = -20 \text{ V}, \qquad I_{D} = -1 \text{ A},$		10	20	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		62	100	ns
t _f	Turn-Off Fall Time			36	58	ns
Q _g	Total Gate Charge, V _{GS} = −10V			45	63	nC
Q _g	Total Gate Charge, V _{GS} = −5V	$V_{DS} = -20 \text{ V}, I_{D} = -14 \text{ A}$		25	35	nC
Q_{gs}	Gate-Source Charge]		7		nC
Q_{gd}	Gate-Drain Charge	7		10		nC

Electrical Characteristics T _A = 25°C unless otherwise noted							
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Drain-Sc	ource Diode Characteristics						
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = -14 \text{ A}$ (Note 2)		-0.8	-1.2	V	
trr	Diode Reverse Recovery Time	IF = -14 A, $diF/dt = 100 A/µs$		28		ns	
Qrr	Diode Reverse Recovery Charge			15		nC	

Notes:

1. R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.



a) $R_{\theta JA} = 40$ °C/W when mounted on a $1in^2$ pad of 2 oz copper



b) $R_{\theta JA} = 96$ °C/W when mounted on a minimum pad.

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width < 300μ s, Duty Cycle < 2.0%

3. Maximum current is calculated as: $\sqrt{\frac{P_D}{R_{DS(ON)}}}$

where P_D is maximum power dissipation at $T_C = 25^{\circ}C$ and $R_{DS(on)}$ is at $T_{J(max)}$ and $V_{GS} = 10V$. Package current limitation is 21A

4. BV(avalanche) Single-Pulse rating is guaranteed if device is operated within the UIS SOA boundary of the device.

Typical Characteristics

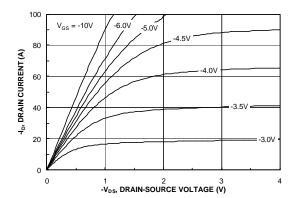


Figure 1. On-Region Characteristics

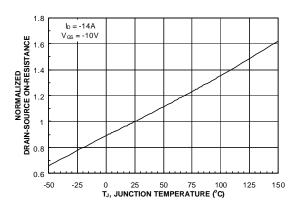


Figure 3. On-Resistance Variation with Temperature

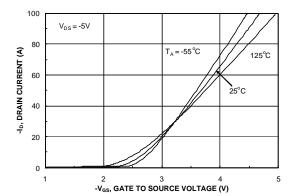


Figure 5. Transfer Characteristics

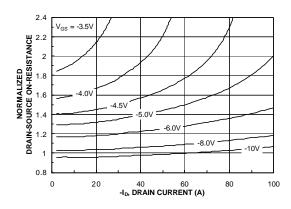


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

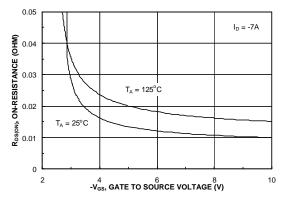


Figure 4. On-Resistance Variation with Gate-to-Source Voltage

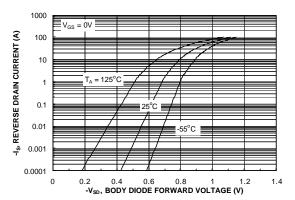


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

Typical Characteristics

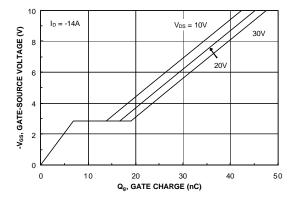


Figure 7. Gate Charge Characteristics

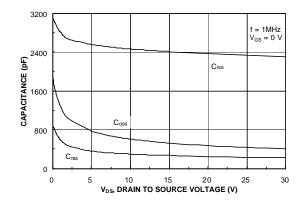


Figure 8. Capacitance Characteristics

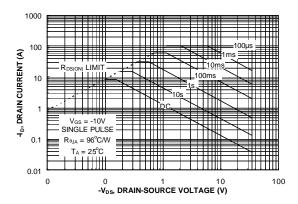


Figure 9. Maximum Safe Operating Area

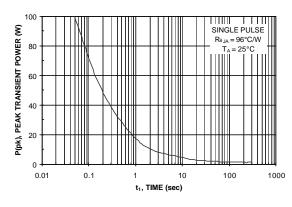


Figure 10. Single Pulse Maximum Power Dissipation

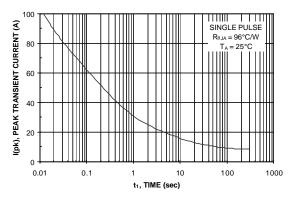


Figure 11. Single Pulse Maximum Peak Current

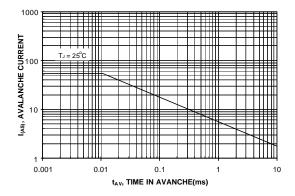


Figure 12. Unclamped Inductive Switching Capability

Typical Characteristics

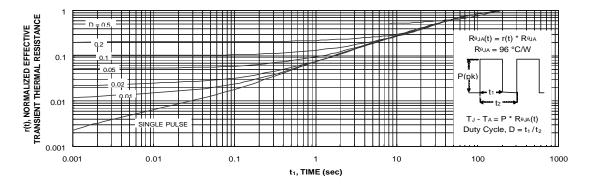


Figure 13. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

Test Circuits and Waveforms

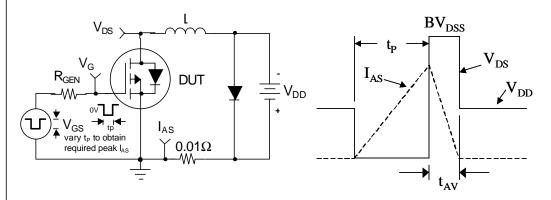


Figure 14. Unclamped Inductive Load Test Circuit

Figure 15. Unclamped Inductive Waveforms

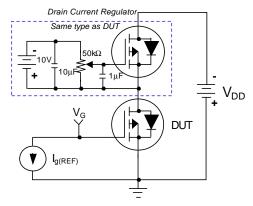


Figure 16. Gate Charge Test Circuit

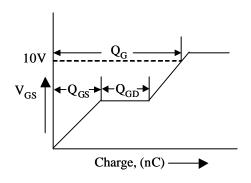


Figure 17. Gate Charge Waveform

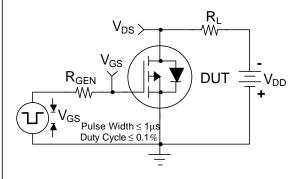


Figure 18. Switching Time Test Circuit

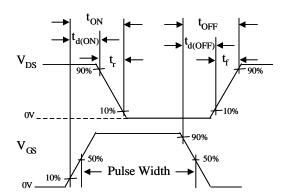
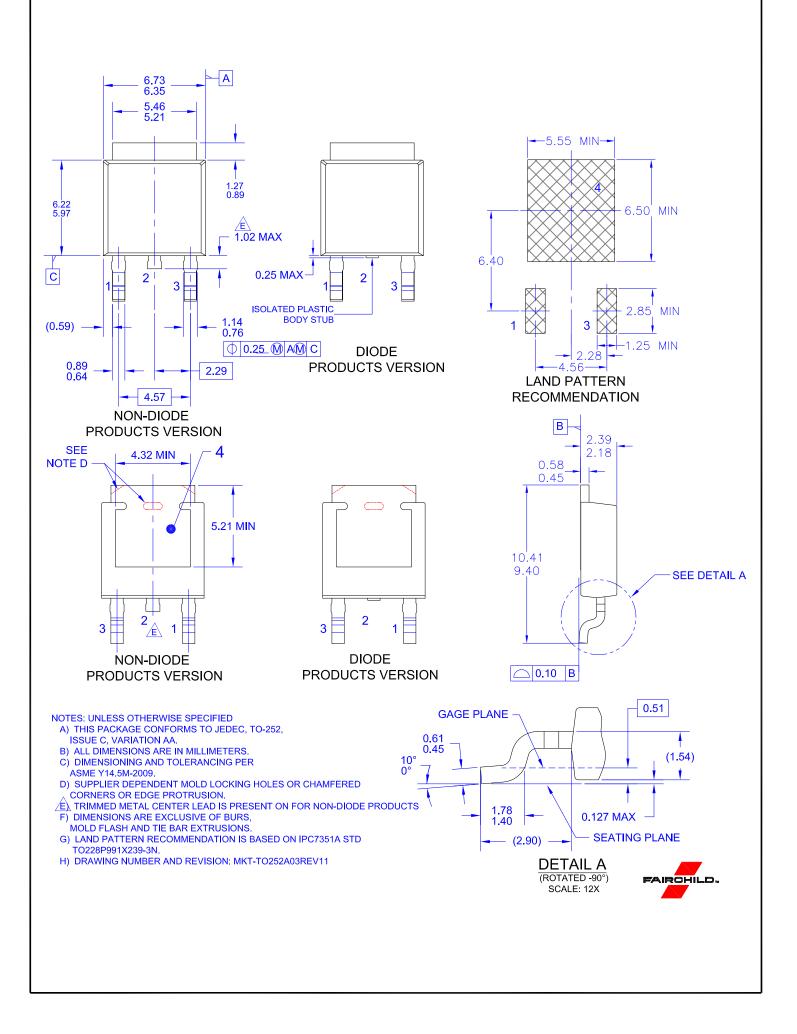


Figure 19. Switching Time Waveforms



ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B